

# MG1500FXF1US71

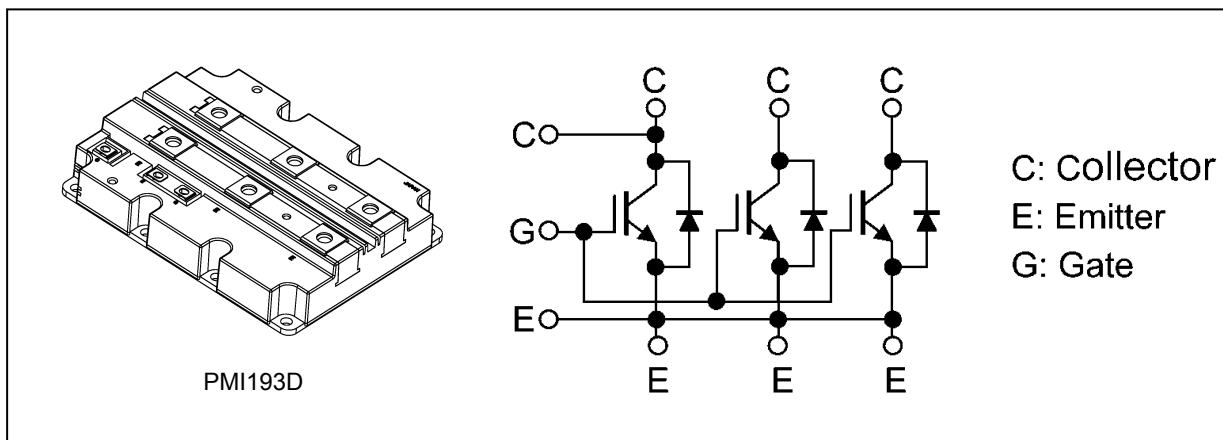
## 1. Applications

- High-Power Switching
- Motor Controllers

## 2. Features

- (1) Enhancement mode.
- (2) Electrodes are isolated from case.
- (3) Embedded Silicon carbide diode.

## 3. Packaging and Internal Circuit Pin Assignment (Note)



Note: Although main E-terminals are connected internally, they cannot lead rating current. Please connect main E-terminals and C-terminals individually with conductive wire capable of leading rating current.

Start of commercial production  
2014-04

**4. Absolute Maximum Ratings (Note) (Unless otherwise specified,  $T_c = 25\text{ }^\circ\text{C}$ )**

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Collector-emitter voltage	$V_{CES}$			3300	V
Gate-emitter voltage	$V_{GES}$			$\pm 20$	V
Collector current (RMS)	$I_{C(RMS)}$	(Note 1)		1500	A
Collector current (pulsed)	$I_{CP}$	(Note 2)	Peak turn-off current	3000	A
Non-repetitive peak forward surge current	$I_{FSM}$		10 ms (half-sine wave)	10	kA
Collector power dissipation	$P_C$			15600	W
Junction temperature	$T_j$			-40 to 150	$^\circ\text{C}$
Storage temperature	$T_{stg}$			-40 to 150	$^\circ\text{C}$
Isolation voltage	$V_{isol}$		AC 1 min	6000	V
Mounting torque	TOR		Terminal: M4/M8	2/7	N · m
			Mounting: M6	4	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1:  $T_c = 100\text{ }^\circ\text{C}$ , without switching losses.

Note 2:  $V_{CP} \leq 3300\text{ V}$ ,  $V_{CC} \leq 2300\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $R_{G(off)} = 2.4\ \Omega$ ,  $T_j \leq 150\text{ }^\circ\text{C}$ ,  $L_s \approx 85\text{ nH}$ .

**5. Thermal Characteristics**

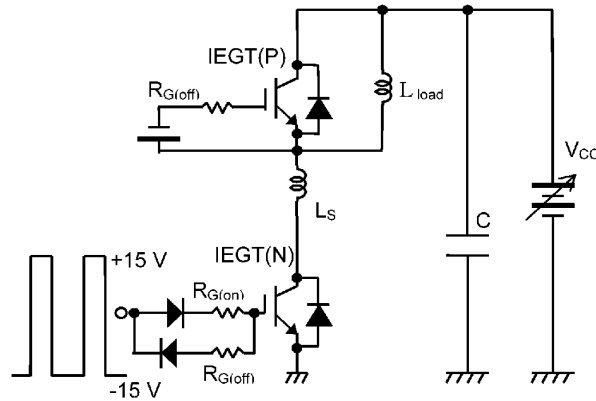
Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Thermal resistance (junction-to-case)	$R_{th(j-c)}$		Transistor part	—	—	8.0	K/kW
	$R_{th(j-c)}$		Diode part	—	—	16	
Thermal resistance (case-to-fin)	$R_{th(c-f)}$	(Note 1)	Per module	—	6.0	—	K/kW

Note 1: The heat radiation grease is recommended for use with semiconductor devices.

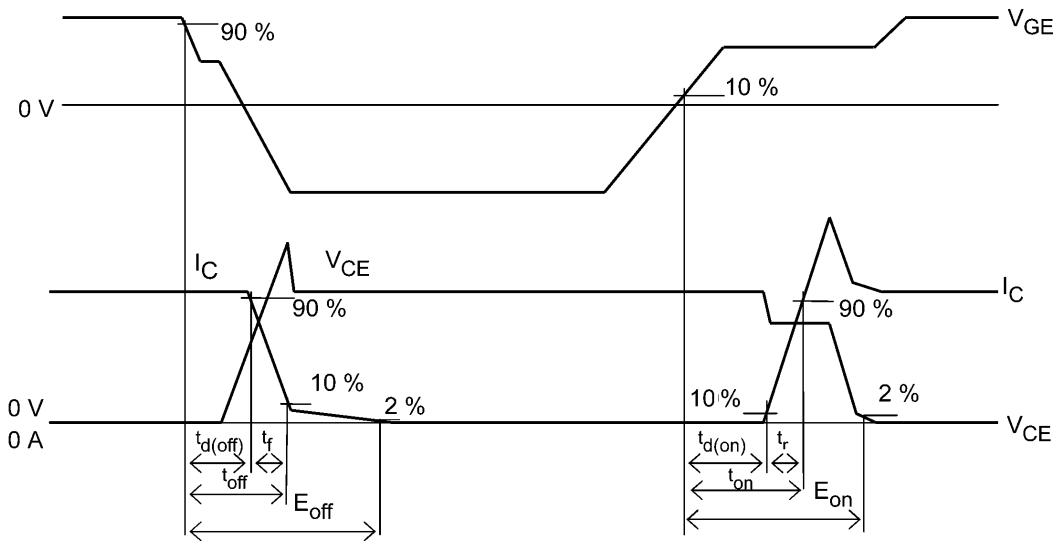
Apply a thin, even (100 to 200  $\mu\text{m}$ ) coating of grease.

**6. Electrical Characteristics (Unless otherwise specified,  $T_C = 25\text{ }^\circ\text{C}$ )**

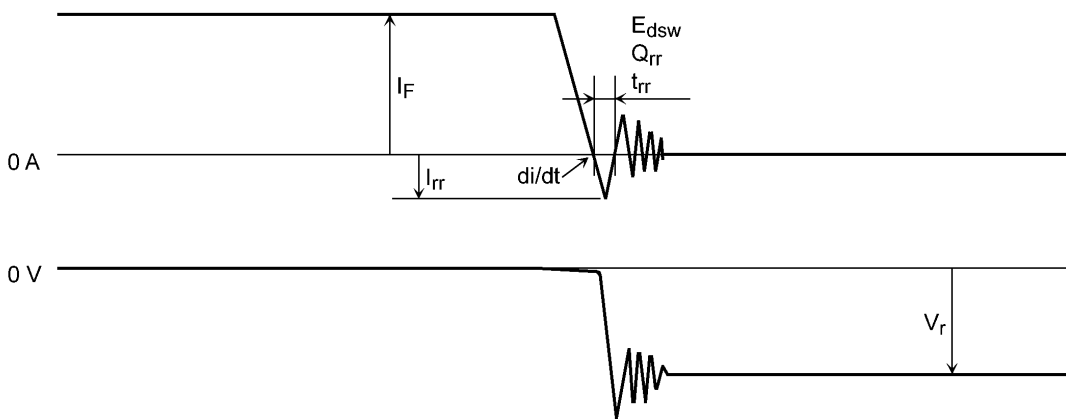
Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Gate-emitter leakage current	$I_{GES}$		$V_{GE} = \pm 20\text{ V}$ , $V_{CE} = 0\text{ V}$	—	—	$\pm 100$	nA
Collector-emitter cut-off current	$I_{CES}$		$V_{CE} = 3300\text{ V}$ , $V_{GE} = 0\text{ V}$ , $T_j = 150\text{ }^\circ\text{C}$	—	—	60	mA
Gate-emitter cut-off voltage	$V_{GE(off)}$		$I_C = 1.5\text{ A}$ , $V_{CE} = 5\text{ V}$ , $T_j = 150\text{ }^\circ\text{C}$	3.8	4.3	4.7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		$I_C = 1500\text{ A}$ , $V_{GE} = 15\text{ V}$ , $T_j = 150\text{ }^\circ\text{C}$	—	3.2	3.8	V
Input capacitance	$C_{ies}$		$V_{CE} = 10\text{ V}$ , $V_{GE} = 0\text{ V}$ , $f = 100\text{ kHz}$	—	175	—	nF
Switching time (turn-on delay time)	$t_{d(on)}$		$V_{CC} = 1800\text{ V}$ , $I_C = 1500\text{ A}$ , $V_{GE} = \pm 15\text{ V}$ , $R_{G(on)} = 1.0\ \Omega$ , $R_{G(off)} = 2.4\ \Omega$ , $T_j = 150\text{ }^\circ\text{C}$ (Inductive load, $L_s \approx 85\text{ nH}$ ) See Fig. 6.1, 6.2	—	0.6	—	$\mu\text{s}$
Switching time (rise time)	$t_r$			—	0.15	—	$\mu\text{s}$
Switching time (turn-on time)	$t_{on}$			—	0.75	—	$\mu\text{s}$
Switching time (turn-off delay time)	$t_{d(off)}$			—	2.8	—	$\mu\text{s}$
Switching time (fall time)	$t_f$			—	1.7	—	$\mu\text{s}$
Switching time (turn-off time)	$t_{off}$			—	4.5	—	$\mu\text{s}$
Forward voltage	$V_F$			$I_F = 1500\text{ A}$ , $V_{GE} = 0\text{ V}$ , $T_j = 150\text{ }^\circ\text{C}$	—	3.6	4.6
Reverse recovery charge	$Q_{rr}$		$V_{CC} = 1800\text{ V}$ , $I_F = 1500\text{ A}$ , $V_{GE} = -15\text{ V}$ , $R_{G(on)} = 1.0\ \Omega$ , $T_j = 150\text{ }^\circ\text{C}$ (Inductive load, $L_s \approx 85\text{ nH}$ ) See Fig. 6.1, 6.3	—	40	—	$\mu\text{C}$
Peak reverse recovery current	$I_{rr}$			—	450	—	A
Reverse recovery time	$t_{rr}$			—	0.14	—	$\mu\text{s}$
Turn-on switching loss	$E_{on}$		$V_{CC} = 1800\text{ V}$ , $I_C = 1500\text{ A}$ , $V_{GE} = \pm 15\text{ V}$ , $R_{G(on)} = 1.0\ \Omega$ , $R_{G(off)} = 2.4\ \Omega$ , $T_j = 150\text{ }^\circ\text{C}$ (Inductive load, $L_s \approx 85\text{ nH}$ ) See Fig. 6.1, 6.2	—	0.7	—	J
Turn-off switching loss	$E_{off}$			—	2.5	—	J
Reverse recovery loss	$E_{dsw}$		$V_{CC} = 1800\text{ V}$ , $I_F = 1500\text{ A}$ , $V_{GE} = -15\text{ V}$ , $R_{G(on)} = 1.0\ \Omega$ , $T_j = 150\text{ }^\circ\text{C}$ (Inductive load, $L_s \approx 85\text{ nH}$ ) See Fig. 6.1, 6.3	—	0.07	—	J



**Fig. 6.1 Inductive Load Switching Test Circuit**

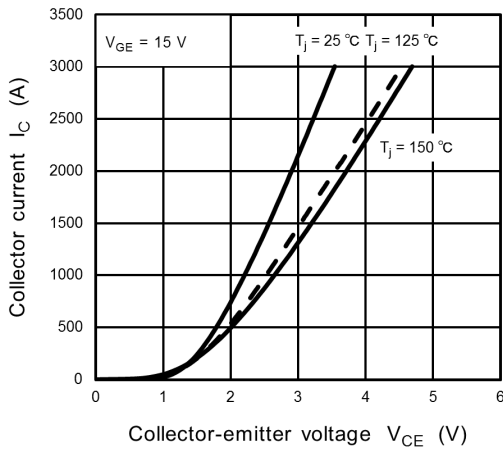


**Fig. 6.2 Timing Chart (Transistor part)**

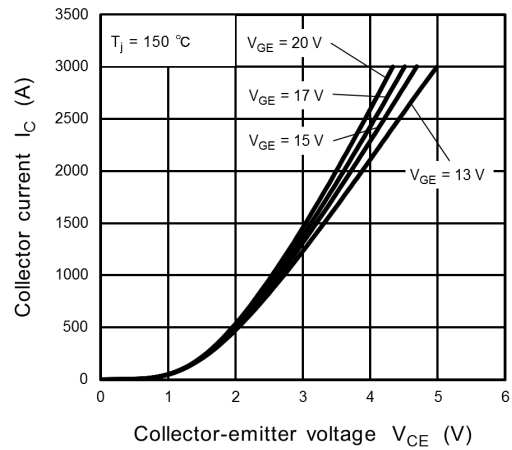


**Fig. 6.3 Timing Chart (Diode part)**

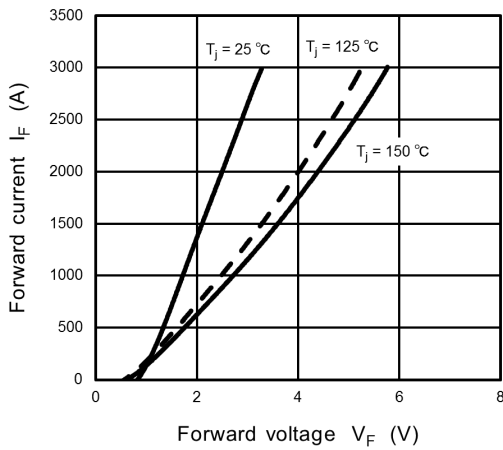
**7. Characteristics Curves (Note)**



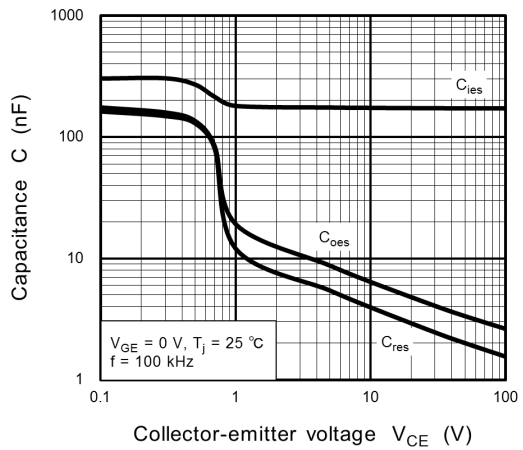
**Fig. 7.1  $I_C - V_{CE}$**



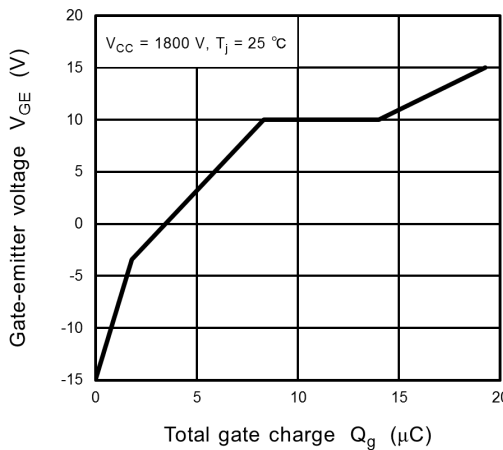
**Fig. 7.2 Output characteristics**



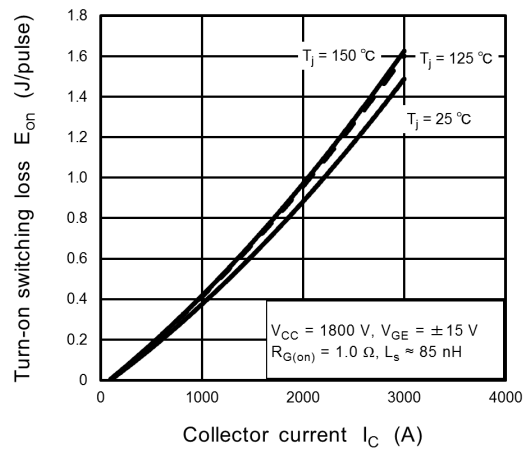
**Fig. 7.3  $I_F - V_F$**



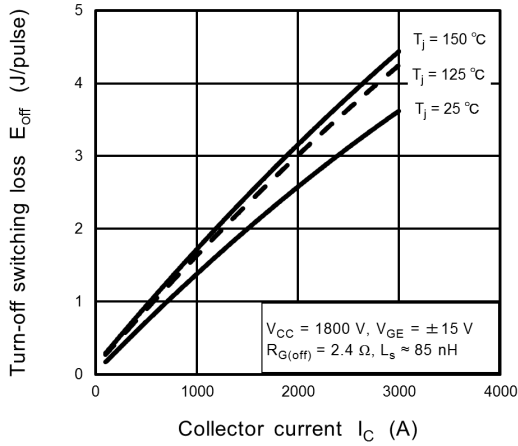
**Fig. 7.4  $C_{ies}, C_{oes}, C_{res} - V_{CE}$**



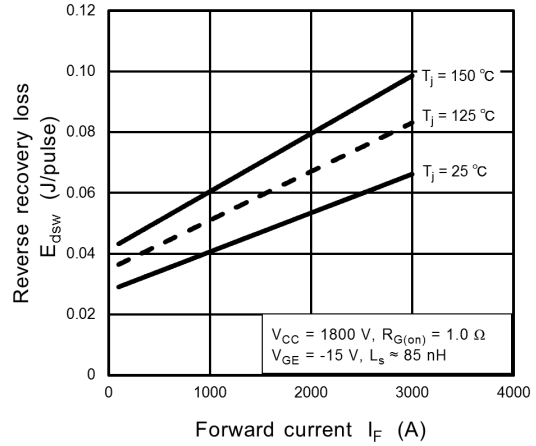
**Fig. 7.5  $V_{GE} - Q_g$**



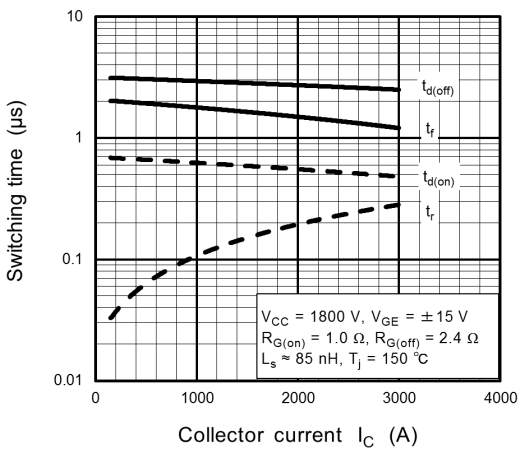
**Fig. 7.6  $E_{on} - I_C$**



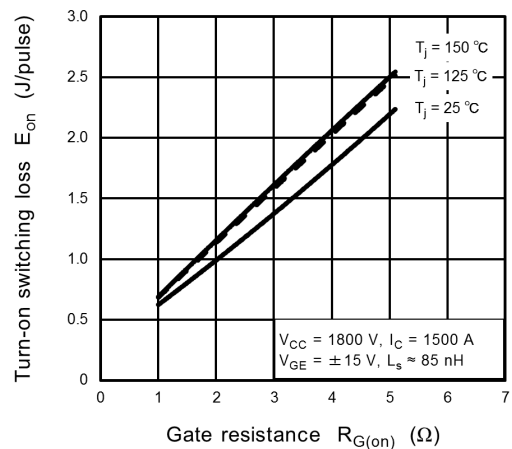
**Fig. 7.7  $E_{off} - I_C$**



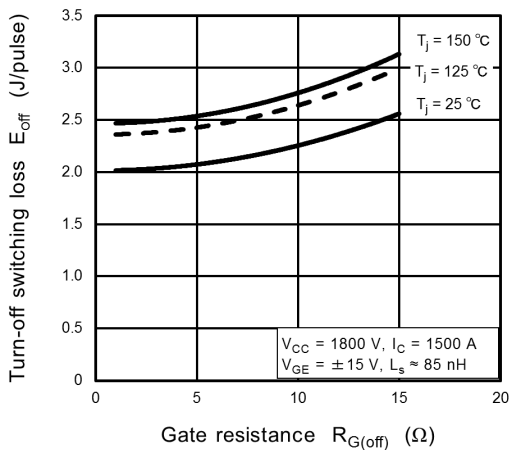
**Fig. 7.8  $E_{dsw} - I_F$**



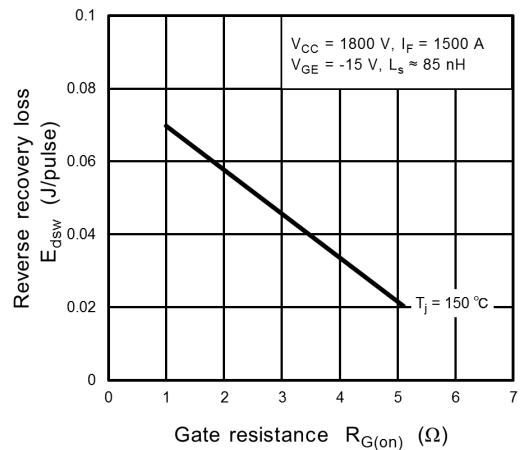
**Fig. 7.9  $t_{d(on)}, t_r, t_{d(off)}, t_r - I_C$**



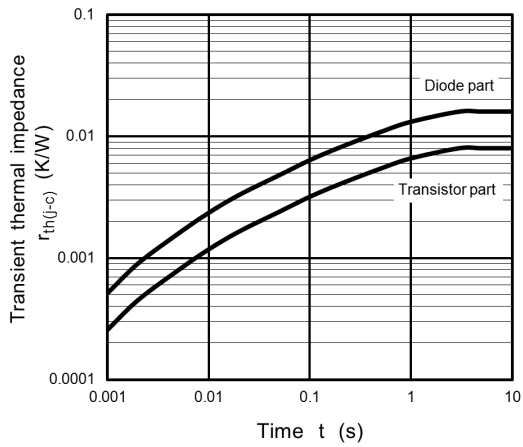
**Fig. 7.10  $E_{on} - R_{G(on)}$**



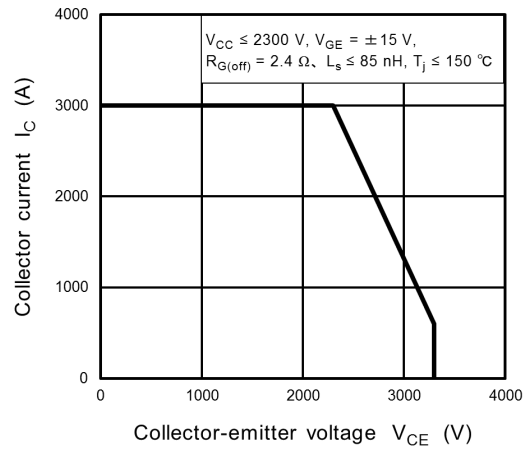
**Fig. 7.11  $E_{off} - R_{G(off)}$**



**Fig. 7.12  $E_{dsw} - R_{G(on)}$**



**Fig. 7.13  $r_{th(j-c)} - t$   
(Guaranteed Maximum)**

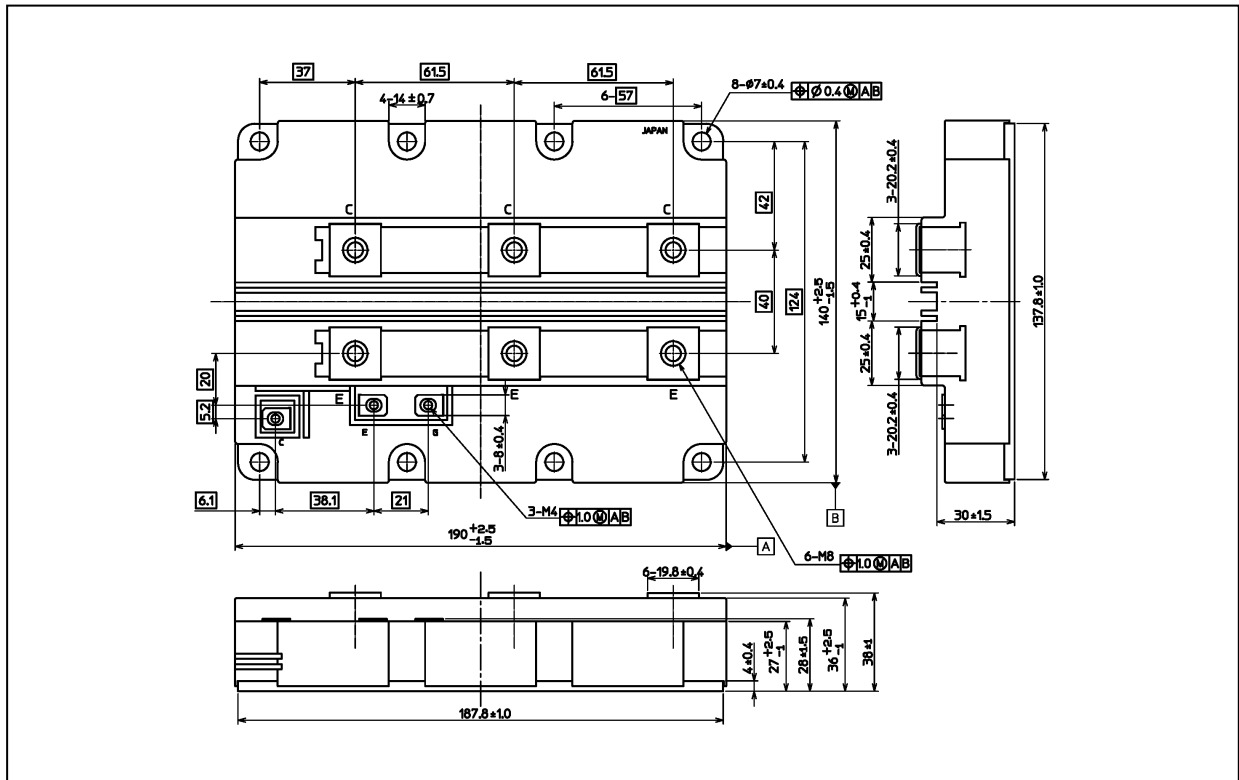


**Fig. 7.14 RBSOA(Guaranteed Maximum)**

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 1200 g (typ.)

Package Name(s)
TOSHIBA: 2-193D1A
Nickname: PMI193D



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